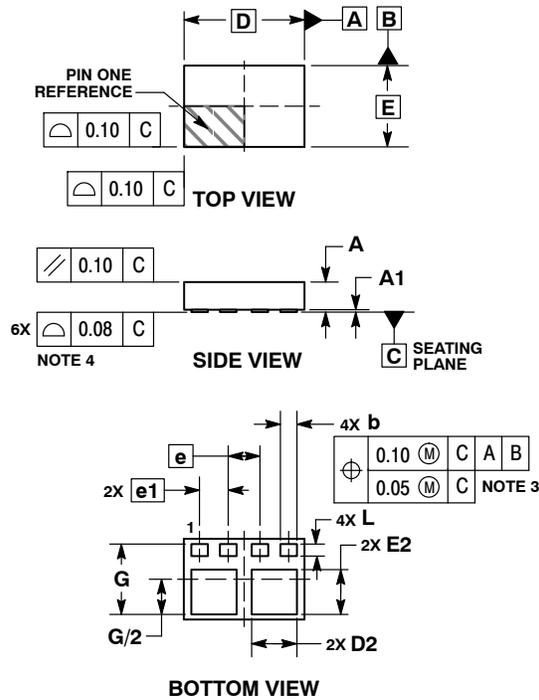




SCALE 4:1

XDFN4 2.0x1.35, 0.525P
CASE 711BD
ISSUE O

DATE 15 SEP 2015

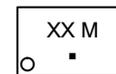


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSIONS b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.25 MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE PADS AS WELL AS THE TERMINALS.

| DIM | MILLIMETERS | |
|-----|-------------|-------|
| | MIN | MAX |
| A | 0.34 | 0.44 |
| A1 | 0.00 | 0.05 |
| b | 0.225 | 0.325 |
| D | 2.00 BSC | |
| D2 | 0.70 | 0.80 |
| E | 1.35 BSC | |
| E2 | 0.70 | 0.80 |
| e | 0.525 BSC | |
| e1 | 0.475 BSC | |
| G | 1.12 | 1.23 |
| L | 0.15 | 0.25 |

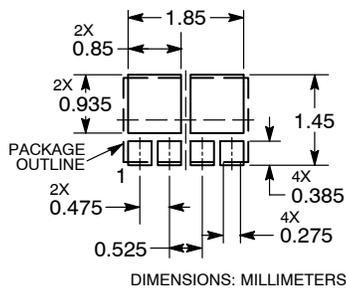
GENERIC MARKING DIAGRAM*



- XX = Specific Device Code
- M = Date Code
- = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present.

RECOMMENDED MOUNTING FOOTPRINT



| | | |
|------------------|------------------------|--|
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| DESCRIPTION: | XDFN4 2.0X1.35, 0.525P | PAGE 1 OF 1 |

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